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IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
TAKATOSHI NISHIZAWA, ET AL. : EXAMINER: VO, H.
SERIAL NO: 10/067,901 :
FILED: FEBRUARY 8, 2002 : GROUP ART UNIT: 1771
FOR: STRETCHED FILM OF VOID- :
CONTAINING THERMOPLASTIC RESIN :
AND PROCESS FOR PRODUCING THE :
SAME :

REQUEST FOR RECONSIDERATION

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Office Action dated July 20, 2005, Applicants request the reconsideration of the rejection of Claims 1 and 3-11, for the reasons set forth below:

The claimed invention is directed to a stretched film of a void-containing thermoplastic resin. As is described in paragraphs [0005]-[0006] of the present specification, such a film, if subject to the usual electrostatic discharge during processing, will retain a residual charge due to the voids in the film. This disadvantageously results in a significant attractive force between the sheets, which makes it difficult to handle the sheets during feeding and removal from offset presses.

According to a feature of the invention, the stretched film of a void containing thermoplastic resin has a surface charge potential, after discharging of the film, of -10 to 10 kV. This is made possible by the application of a DC current voltage overlaid on a high voltage and high frequency voltage during discharging of the film, and maintains an attractive